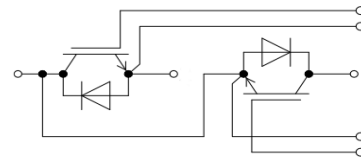


Features:

- 1200V100A, VCE(sat)(typ.)=3.0V Low
- inductive design
- Lower losses and higher energy
- Ultrafast switching speed
- Excellent short circuit ruggedness


General Applications:

- Auxiliary Inverter
- Inductive Heating and Welding
- UPS Systems


Absolute Maximum Ratings of IGBT

Equivalent Circuit Schematic

V_{CES}	Collector to Emitter Voltage		1200	V
V_{GES}	Continuous Gate to Emitter Voltage		± 30	V
I_C	Continuous Collector Current	$T_C = 25^\circ\text{C}$	200	A
		$T_C = 100^\circ\text{C}$	100	
I_{CM}	Pulse Collector Current	$T_J = 150^\circ\text{C}$	200	A
P_D	Maximum Power Dissipation (IGBT)	$T_C = 25^\circ\text{C}$,	430	W
t_{sc}	Short Circuit Withstand Time	$T_J = 150^\circ\text{C}$	> 10	μs
T_J	Maximum IGBT Junction Temperature		150	$^\circ\text{C}$
T_{JOP}	Maximum Operating Junction Temperature Range		-40 to +150	$^\circ\text{C}$
T_{stg}	Storage Temperature Range		-40 to +125	$^\circ\text{C}$

Absolute Maximum Ratings of Freewheeling Diode

V_{RRM}	Repetitive Peak Reverse Voltage Preliminary Data		1200	V
I_F	Diode Continuous Forward Current	$T_C = 25^\circ\text{C}$	200	A
		$T_C = 100^\circ\text{C}$	100	
I_{FM}	Diode Maximum Forward Current		200	A

Electrical Characteristics of IGBT at T_J = 25°C (Unless Otherwise Specified)

Parameter	Test Conditions	Min	Typ	Max	Unit	
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 1mA	1200		V	
I _{CES}	Collector to Emitter Leakage Current	V _{GE} = 0V, V _{CE} = V _{CES}		1	mA	
I _{GES}	Gate to Emitter Leakage Current	V _{GE} = ±30V, V _{CE} = 0V		200	nA	
V _{GE(th)}	Gate Threshold Voltage	I _C = 1mA, V _{CE} = V _{GE}	4.5	5.7	V	
V _{CE(sat)}	Collector to Emitter Saturation Voltage (Module Level)	I _C = 100A, V _{GE} = 15V	T _J = 25°C	3.00	3.20	V
			T _J = 125°C	3.60		

Switching Characteristics of IGBT

Parameter	Test Conditions	Min	Typ	Max	Unit
t _{d(on)}	Turn-on Delay Time	T _J = 25°C	30		ns
		T _J = 125°C	35		
t _r	Turn-on Rise Time	T _J = 25°C	50		ns
		T _J = 125°C	55		
t _{d(off)}	Turn-off Delay Time	T _J = 25°C	380		ns
		T _J = 125°C	390		
t _f	Turn-off Fall Time	T _J = 25°C	110		ns
		T _J = 125°C	160		
E _{on}	Turn-on Switching Loss	T _J = 25°C	4.60		mJ
		T _J = 125°C	5.70		
E _{off}	Turn-off Switching Loss	T _J = 25°C	3.10		mJ
		T _J = 125°C	5.10		
Q _g	Total Gate Charge	T _J = 25°C	870		nC
R _{gint}	Integrated gate resistor	f = 1M; V _{pp} = 1V	T _J = 25°C	1.9	Ω
C _{ies}	Input Capacitance	V _{CE} = 25V V _{GE} = 0V f = 1MHz	T _J = 25°C	8.00	nF
C _{oes}	Output Capacitance		T _J = 25°C	1.35	
C _{res}	Reverse Transfer Capacitance		T _J = 25°C	0.81	
R _{θJC}	Thermal Resistance, Junction-to-Case (IGBT)			0.29	°C/W

Electrical and Switching Characteristics of Freewheeling Diode

V _F	Diode Forward Voltage	I _F = 100A , V _{GE} = 0V	T _J = 25℃	1.90	2.20	V
			T _J = 125℃	1.90		
t _{rr}	Diode Reverse Recovery Time	I _F = 100A, di/dt=1600A/μs, V _{rr} = 600V,	T _J = 25℃	80		ns
			T _J = 125℃	120		
I _{rr}	Diode Peak Reverse Recovery Current	I _F = 100A, di/dt=1600A/μs, V _{rr} = 600V,	T _J = 25℃	120		A
			T _J = 125℃	135		
Q _{rr}	Diode Reverse Recovery Charge	I _F = 100A, di/dt=1600A/μs, V _{rr} = 600V,	T _J = 25℃	8.0		nC
			T _J = 125℃	12.0		
E _{rr}	Diode Reverse Recovery Energy	I _F = 100A, di/dt=1600A/μs, V _{rr} = 600V,	T _J = 25℃	3.70		mJ
			T _J = 125℃	6.20		
R _{θJC}	Thermal Resistance, Junction-to-Case (Diode)				0.46	°C/W

Module Characteristics

Parameter		Min.	Typ.	Max.	Unit
V _{iso}	Isolation Voltage (All Terminals Shorted),f = 50Hz, 1minute			2500	V
R _{θCS}	Case-To-Sink(Conductive Grease Applied)		0.1		°C/W
M	Power Terminals Screw: M5	3.0		5.0	N·m
M	Mounting Screw: M6	4.0		6.0	N·m
G	Weight		160		g

YZPST-G100HF120D1

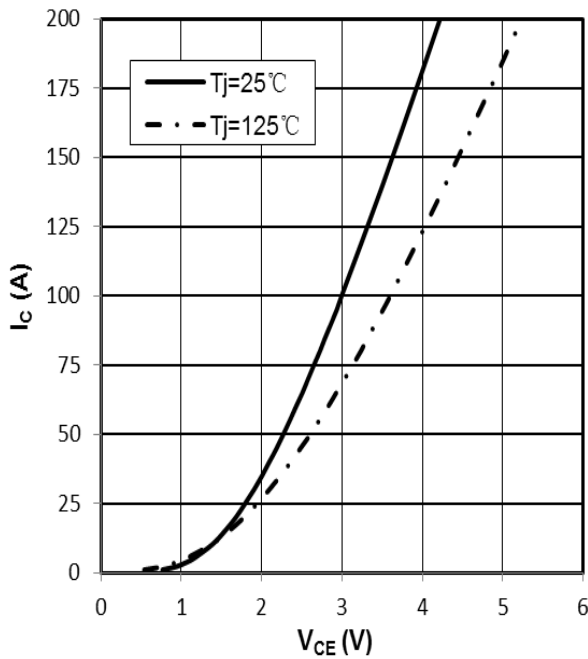


Fig 1. output characteristic IGBT,
 $I_c=f(V_{CE}), V_{GE}=15V$

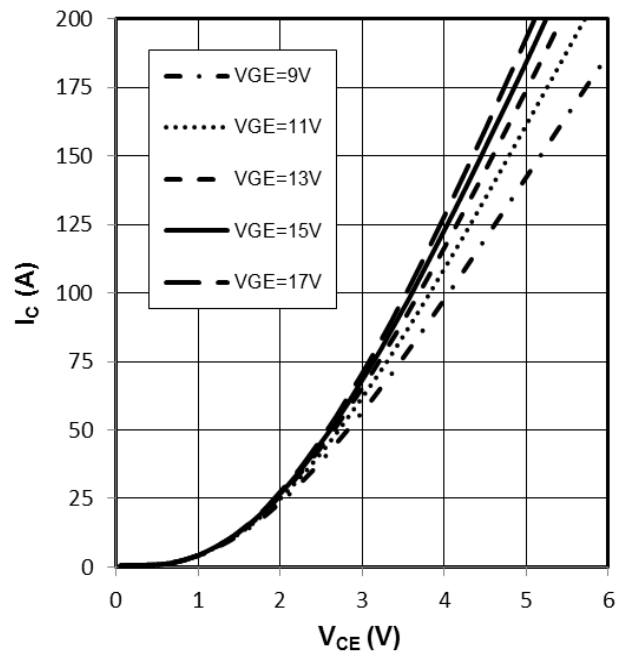


Fig 2. output characteristic IGBT,
 $I_c=f(V_{CE}), T_j=125^\circ C$

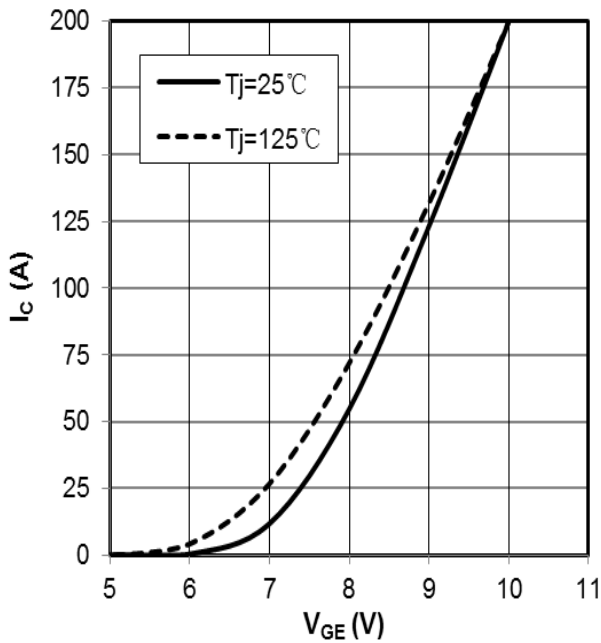


Fig 3. transfer characteristic IGBT,
 $I_c=f(V_{GE}), V_{CE}=20V$

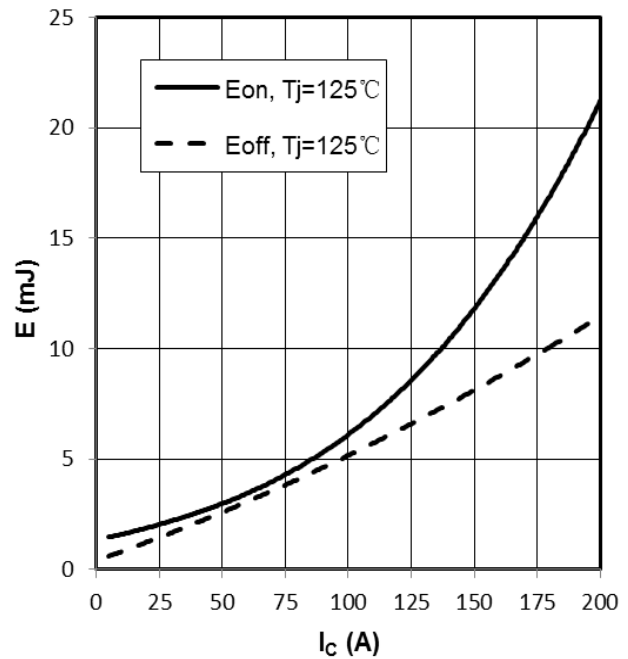


Fig 4. switching losses IGBT, $E_{on}=f(I_c), E_{off}=f(I_c)$,
 $V_{GE}=\pm 15V, R_{Gon}=5.6\Omega, R_{Goff}=5.6\Omega, V_{CE}=600V$

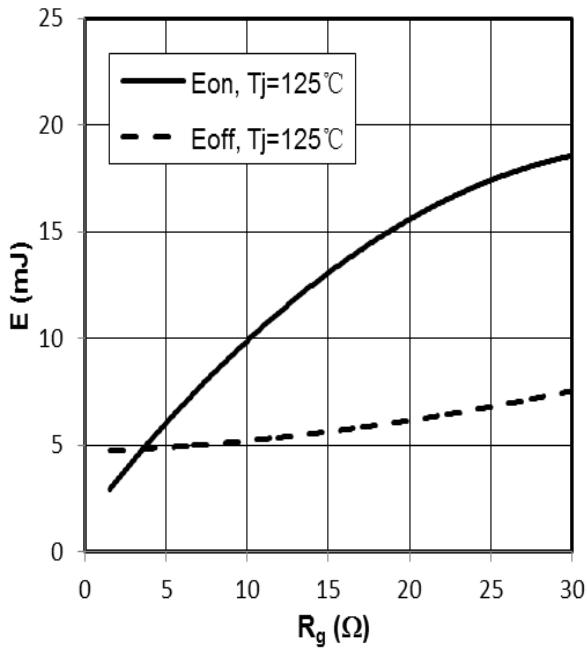


Fig 5. switching losses IGBT, $E_{on}=f(R_G), E_{off}=f(R_G)$, $V_{GE}=\pm 15V, I_C=100A, V_{CE}=600V$

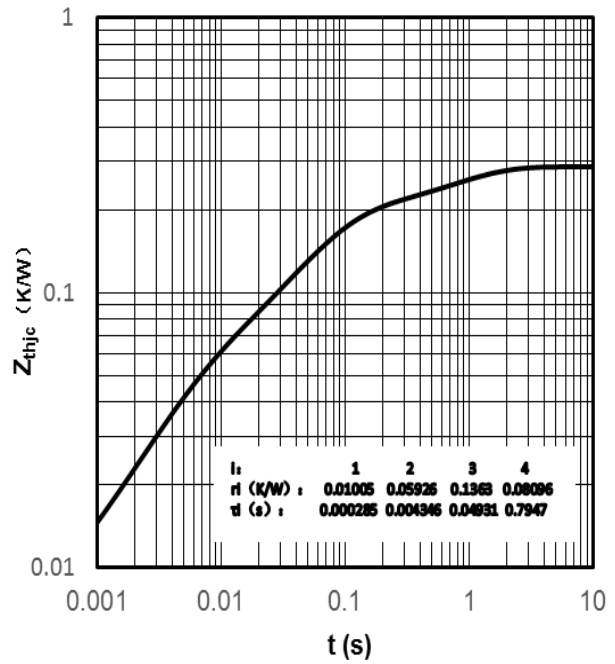


Fig 6. transient thermal impedance IGBT, $Z_{thjc}=f(t)$

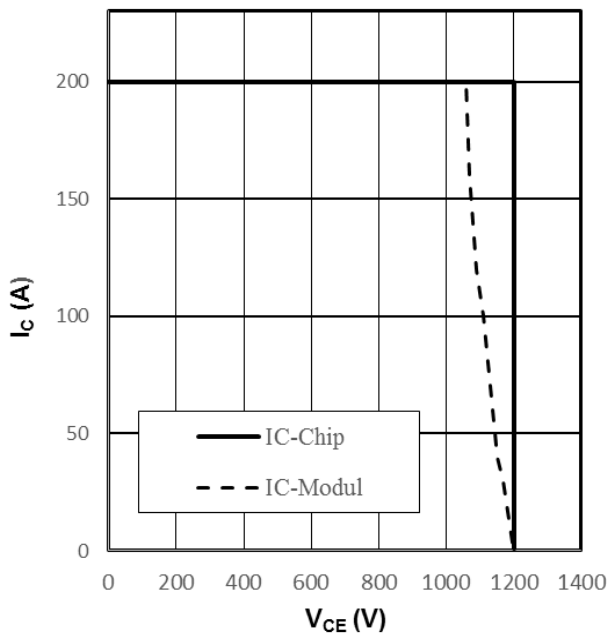


Fig 7. reverse bias safe operating area IGBT, $I_C=f(V_{CE}), V_{GE}=\pm 15V, R_{Goff}=5.6\Omega, T_{vj}=125^\circ C$

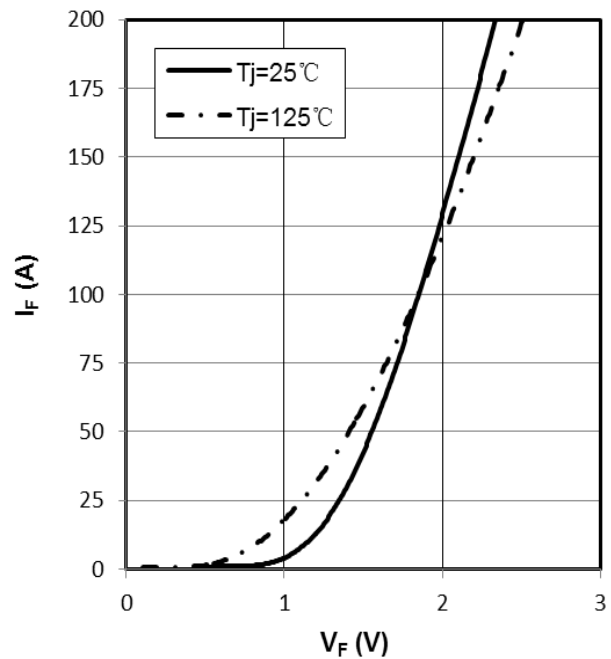


Fig 8. forward characteristic of Diode, $I_F=f(V_F)$

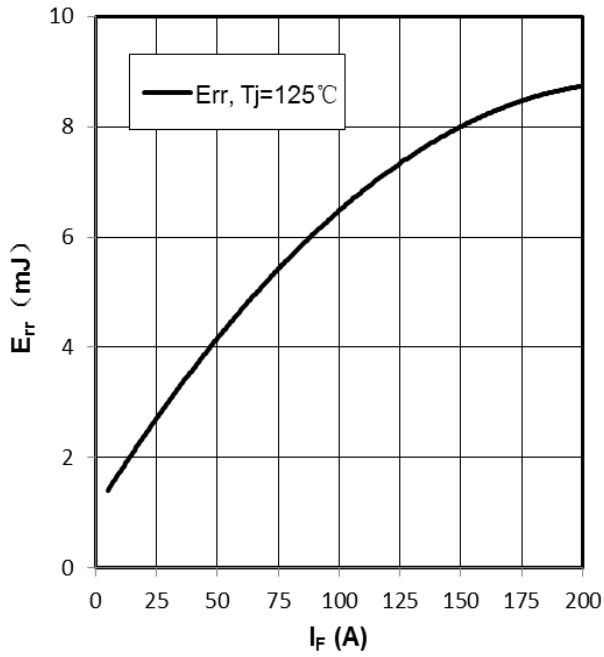


Fig 9. switching losses Diode,
 $E_{rr}=f(I_F)$, $R_{Gon}=5.6\Omega$, $V_{CE}=600V$

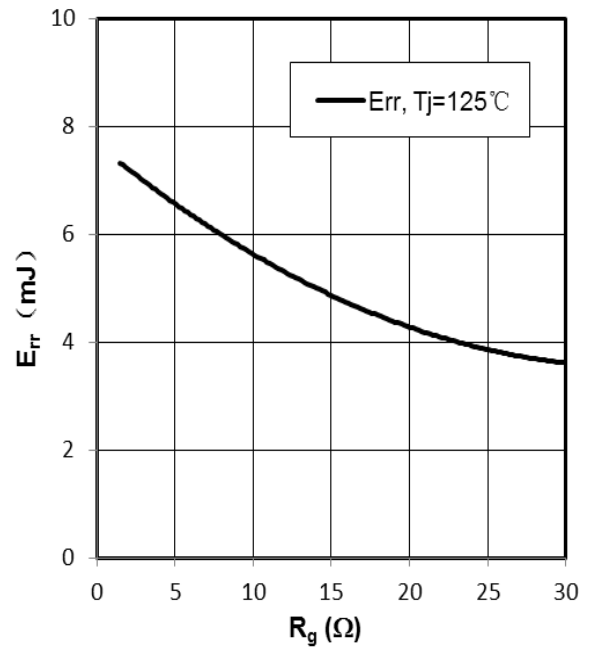
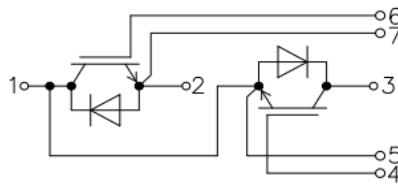


Fig 10. switching losses Diode,
 $E_{rr}=f(R_g)$, $I_F=100A$, $V_{CE}=600V$

Circuit:



Package Dimension

